imall

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IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Optimized for Very Low V_{CEsat}
- Low Switching Loss Reduces System Power Dissipation
- Soft Fast Reverse Recovery Diode
- 5 µs Short–Circuit Capability
- These are Pb–Free Devices

Typical Applications

• Power Factor Correction

ABSOLUTE MAXIMUM RATINGS

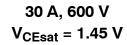
| | · | 1 | r |
|--|------------------|-------------|------|
| Rating | Symbol | Value | Unit |
| Collector-emitter voltage | V _{CES} | 600 | V |
| Collector current @ Tc = 25°C @ Tc = 100°C | Ιc | 60 30 | A |
| Pulsed collector current, T _{pulse} limited by T _{Jmax} | I _{CM} | 120 | A |
| Diode Forward Current @ T _C = 25°C @ T _C = 100°C | IF | 60 30 | A |
| Diode Pulsed Current T _{pulse} Limited by T _{Jmax} | I _{FM} | 120 | A |
| Short–circuit withstand time V_{GE} = 15 V, V_{CE} = 300 V, $T_J \le +150^{\circ}C$ | t _{SC} | 5 | μs |
| Gate-emitter voltage Transient Gate Emitter Voltage ($t_p = 5 \ \mu s, D < 0.010$) | V _{GE} | ±20 ±30 | V |
| Power Dissipation @ Tc = 25°C @ Tc = 100°C | P _D | 167 67 | W |
| Operating junction temperature range | ТJ | –55 to +150 | °C |
| Storage temperature range | T _{stg} | –55 to +150 | °C |
| Lead temperature for soldering, 1/8" from case for 5 seconds | T _{SLD} | 260 | °C |
| | | | |

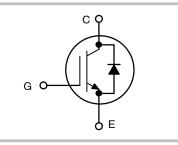
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

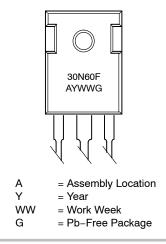
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MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping |
|--------------|---------------------|-----------------|
| NGTB30N60FWG | TO-247 (Pb-Free) | 30 Units / Rail |

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THERMAL CHARACTERISTICS

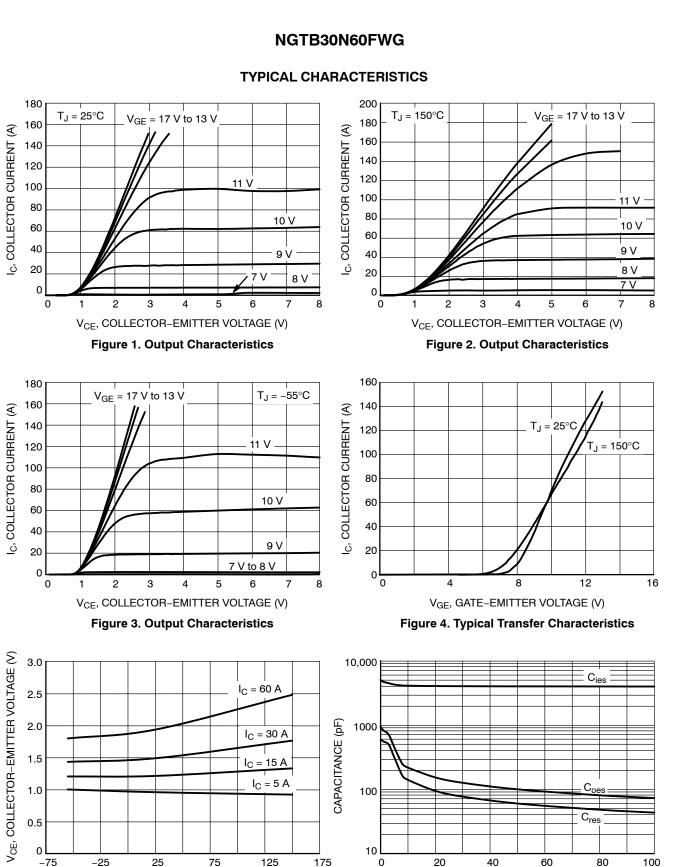
| Rating | Symbol | Value | Unit |
|--|---------------------|-------|------|
| Thermal resistance junction-to-case, for IGBT | $R_{	ext{	heta}JC}$ | 0.75 | °C/W |
| Thermal resistance junction-to-case, for Diode | $R_{	ext{	heta}JC}$ | 1.06 | °C/W |
| Thermal resistance junction-to-ambient | $R_{	hetaJA}$ | 40 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|---|--|----------------------|-----------|--------------|-----------|------|
| STATIC CHARACTERISTIC | - | - | | - | - | - |
| Collector-emitter breakdown voltage, gate-emitter short-circuited | V_{GE} = 0 V, I _C = 500 µA | V _{(BR)CES} | 600 | - | _ | V |
| Collector-emitter saturation voltage | V_{GE} = 15 V, I _C = 30 A V_{GE} = 15 V, I _C = 30 A, T _J = 150°C | V _{CEsat} | 1.25 - | 1.45 1.75 | 1.70 - | V |
| Gate-emitter threshold voltage | V_{GE} = V_{CE} , I_C = 200 μ A | V _{GE(th)} | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gate- emitter short-circuited | $V_{GE} = 0 V, V_{CE} = 600 V$ $V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150^{\circ}C$ | I _{CES} | | | 0.2 2 | mA |
| Gate leakage current, collector-emitter short-circuited | V_{GE} = 20 V , V_{CE} = 0 V | I _{GES} | _ | - | 100 | nA |
| DYNAMIC CHARACTERISTIC | · | | | | | |
| Input capacitance | | C _{ies} | - | 4100 | - | pF |
| Output capacitance | V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz | C _{oes} | - | 150 | - | |
| Reverse transfer capacitance | | C _{res} | - | 95 | - | |
| Gate charge total | | Qg | | 170 | | nC |
| Gate to emitter charge | V_{CE} = 480 V, I _C = 30 A, V _{GE} = 15 V | Q _{ge} | | 34 | | |
| Gate to collector charge | | Q _{gc} | | 83 | | |
| SWITCHING CHARACTERISTIC, INDUC | | | | | | |
| Turn-on delay time | | t _{d(on)} | | 81 | | ns |
| Rise time | 1 | t _r | | 31 | | |
| Turn-off delay time | T _J = 25°C | t _{d(off)} | | 190 | | |
| Fall time | $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$ | t _f | | 110 | | |
| Turn-on switching loss | $V_{GE} = 0 V/15 V$ | E _{on} | | 0.65 | | mJ |
| Turn-off switching loss | | E _{off} | | 0.65 | | |
| Total switching loss | | E _{ts} | | 1.30 | | |
| Turn-on delay time | | t _{d(on)} | | 80 | | ns |
| Rise time | | t _r | | 32 | | |
| Turn-off delay time | T _J = 150°C | t _{d(off)} | | 200 | | |
| Fall time | $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $R_{a} = 10 \Omega$ | t _f | | 230 | | |
| Turn-on switching loss | $R_g = 10 \Omega$ $V_{GE} = 0 V/ 15 V$ | E _{on} | | 0.80 | | mJ |
| Turn-off switching loss |] | E _{off} | | 1.1 | | |
| Total switching loss |] | E _{ts} | | 1.90 | | |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|--------------------------|--|------------------|------|------|------|------|
| DIODE CHARACTERISTIC | | | | | | |
| Forward voltage | V_{GE} = 0 V, I _F = 30 A V_{GE} = 0 V, I _F = 30 A, T _J = 150°C | V _F | 1.45 | 1.90 | 2.35 | V |
| Reverse recovery time | T,₁ = 25°C | t _{rr} | | 72 | | ns |
| Reverse recovery charge | I _F = 30 Å, V _R = 200 V | Q _{rr} | | 15 | | μC |
| Reverse recovery current | di _F /dt = 200 A/µs | I _{rrm} | | 6 | | А |

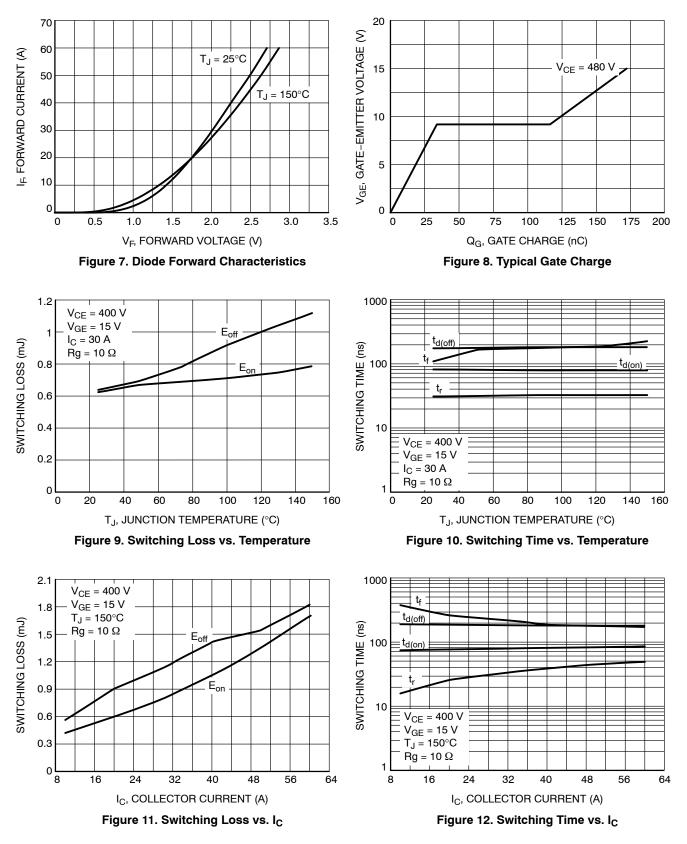


V_{CE}, COLLECTOR–EMITTER VOLTAGE (V) Figure 6. Typical Capacitance

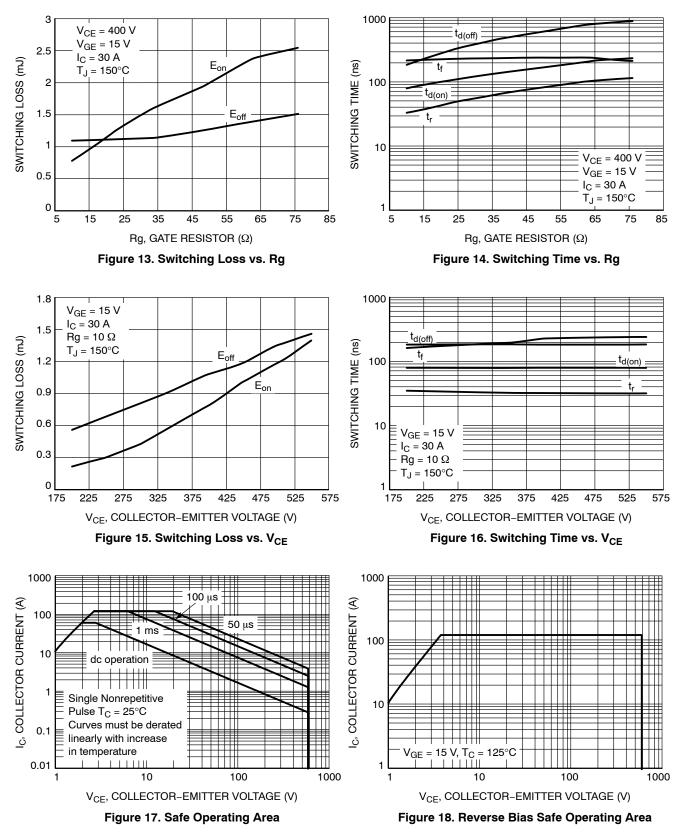
TJ, JUNCTION TEMPERATURE (°C)

Figure 5. V_{CE(sat)} vs. T_J

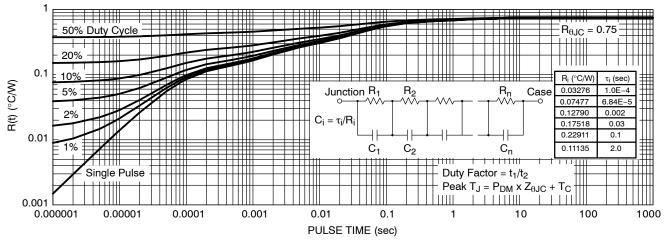
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





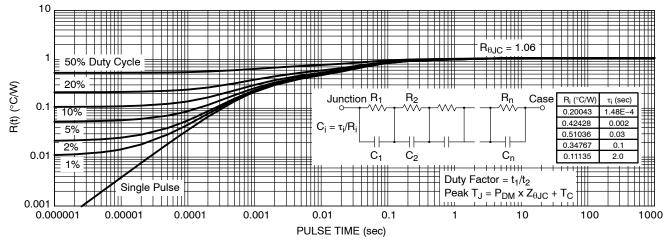


Figure 20. Diode Transient Thermal Impedance

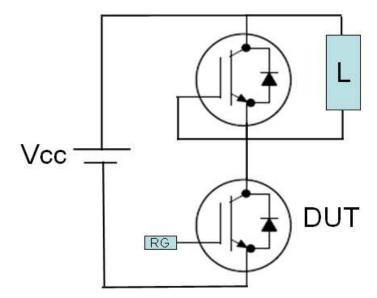
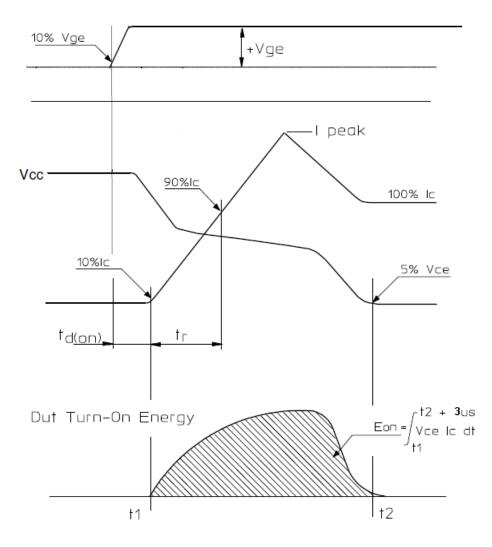
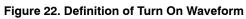


Figure 21. Test Circuit for Switching Characteristics





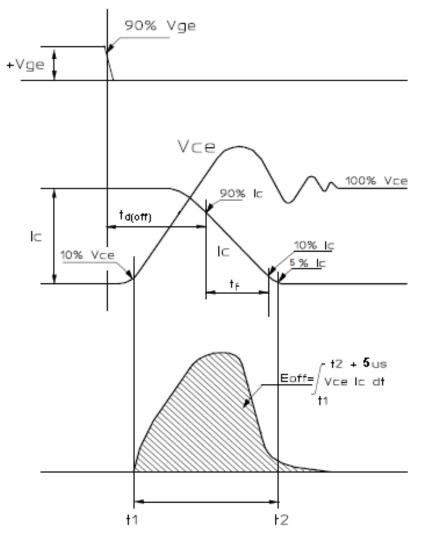
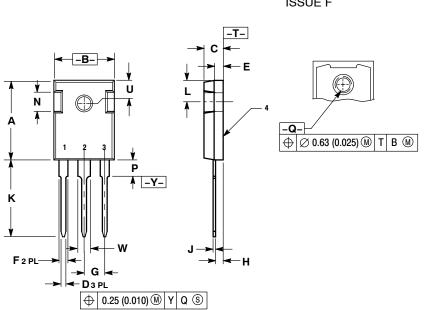


Figure 23. Definition of Turn Off Waveform

PACKAGE DIMENSIONS



TO-247 CASE 340L-02 **ISSUE F**

| DIMEN Y14.5M | A, 1982. | | Lerancii On: Milli | ng per ai Imeter. | |
|---------------------|--------------------|--------|-----------------------|----------------------|--|
| | MILLIN | IETERS | INC | HES | |
| DIM | MIN | MAX | MIN | MAX | |
| Α | 20.32 | 21.08 | 0.800 | 8.30 | |
| В | 15.75 | 16.26 | 0.620 | 0.640 | |
| С | 4.70 | 5.30 | 0.185 | 0.209 | |
| D | 1.00 | 1.40 | 0.040 | 0.055 | |
| E | 1.90 | 2.60 | 0.075 | 0.102 | |
| F | 1.65 | 2.13 | 0.065 | 0.084 | |
| G | 5.45 | BSC | 0.215 BSC | | |
| Н | 1.50 | 2.49 | 0.059 | 0.098 | |
| J | 0.40 | 0.80 | 0.016 | 0.031 | |
| K | 19.81 | 20.83 | 0.780 | 0.820 | |
| L | 5.40 | 6.20 | 0.212 | 0.244 | |
| N | 4.32 | 5.49 | 0.170 | 0.216 | |
| Ρ | | 4.50 | | 0.177 | |
| Q | 3.55 | 3.65 | 0.140 | 0.144 | |
| U | 6.15 BSC 0.242 BSC | | | | |
| W | 2.87 | 3.12 | 0.113 | 0.123 | |

STYLE 4:

PIN 1. GATE 2. COLLECTOR 3. EMITTER

4. COLLECTOR

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